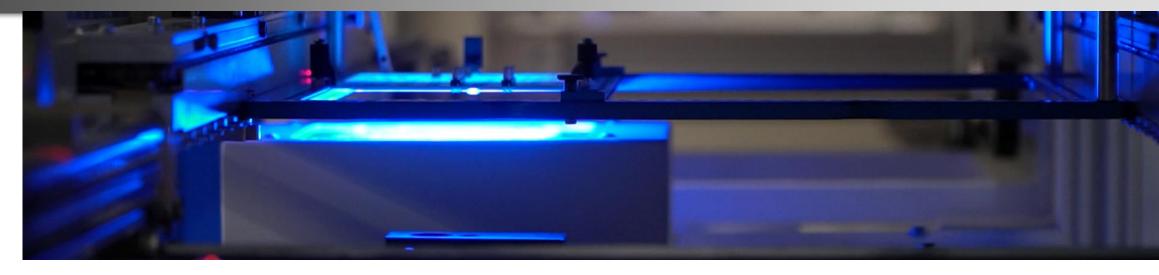




Controlled, Error-Free THT Results

SEHO Inspection Solutions





WHY THT-AOI

- 100% defect-free production process
- 100% documented process, independent from human biorhythm

REQUIREMENTS

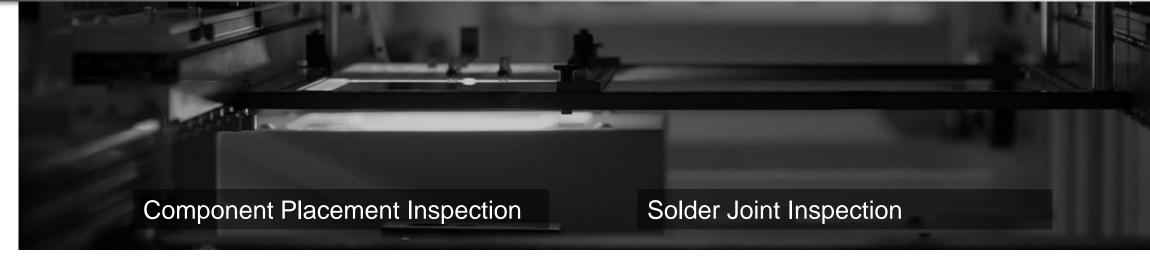
- no non-detected defects at lowest possible pseudo defect rate
- cycle time
- enable cost-efficient rework
- flexible integration into the production process



THT Processes

Typical Inspection Tasks



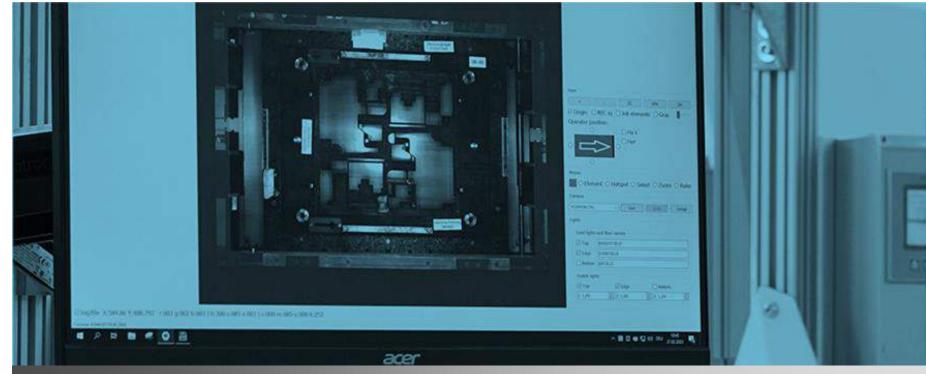


- presence of components
- completeness
- correct orientation / polarity
- OCV
- colour recognition and check
- reading of codes

- bridges
- solder balls
- open solder joints
- insufficient wetting
- missing pin
- missing meniscus
- washed-off SMD's
- reading of product ID's







AssemblyCheck: Component Placement Inspection



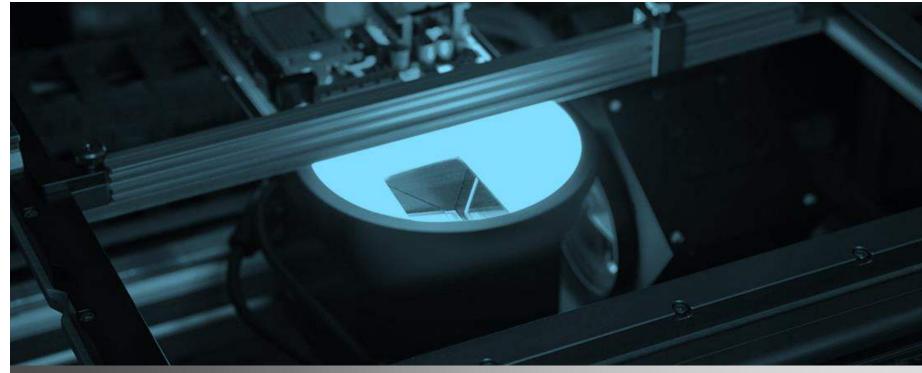


- eliminates possible errors
- ✓ significant increase in quality and yield









PowerVision: THT-AOI



PowerVision

Integrated in a SEHO Selective Soldering System



ADVANTAGES

- assemblies with defects automatically can be removed from the production line
- no additional space required
- cost-efficient: the entire handling of the assembly is made by the soldering system

Available for almost all Selective Soldering
Systems made by SEHO





Integrated in SEHO PowerSelective





mounted stationary in the production cell

for applications that are not critical in terms of cycle times



parallel process, no influence on cycle time





SEHO PowerVision Integrated in SEHO SelectLine

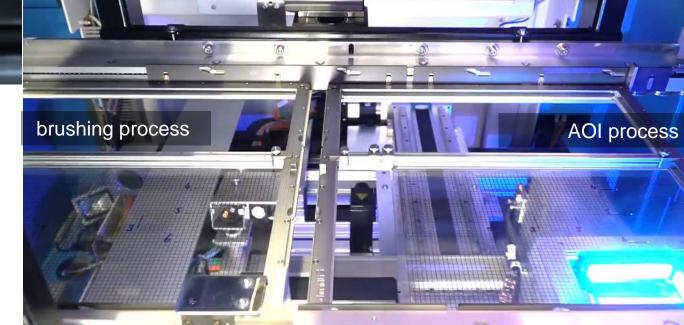




integrated in any SelectLine module

- after soldering process
- after brushing process





Integrated in SEHO SelectLine Example



SEHO PowerSelective

selective brushing and AOI performed in

a parallel process on two stations (module: SelectLine-C product group)

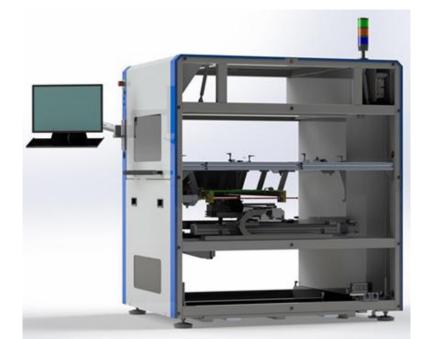


SEHO AssemblyCheck I SEHO PowerVision Integration into any THT Production Line (Wave or Selective)



Stand-Alone Module

solder joint inspection inline after any wave or selective soldering machine





SEHO AssemblyCheck I SEHO PowerVision

Integration into any THT Production Line (Wave or Selective)



installed in front of any wave or selective soldering system

SEHO Assembly Check – placement inspection at assembly conveyor level

SEHO PowerVision – solder joint inspection at return conveyor level



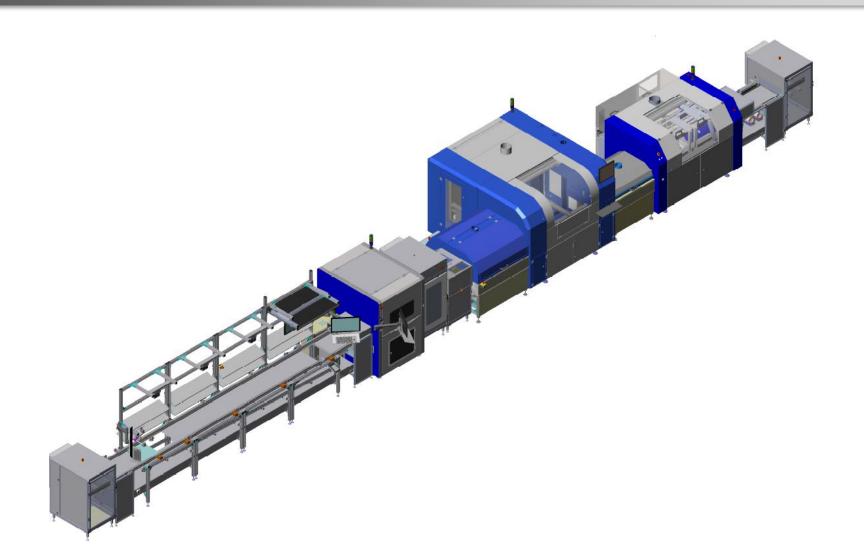
Stand-Alone Module

- cost saving solution
- minimal space requirements



SEHO AssemblyCheck I SEHO PowerVision Example

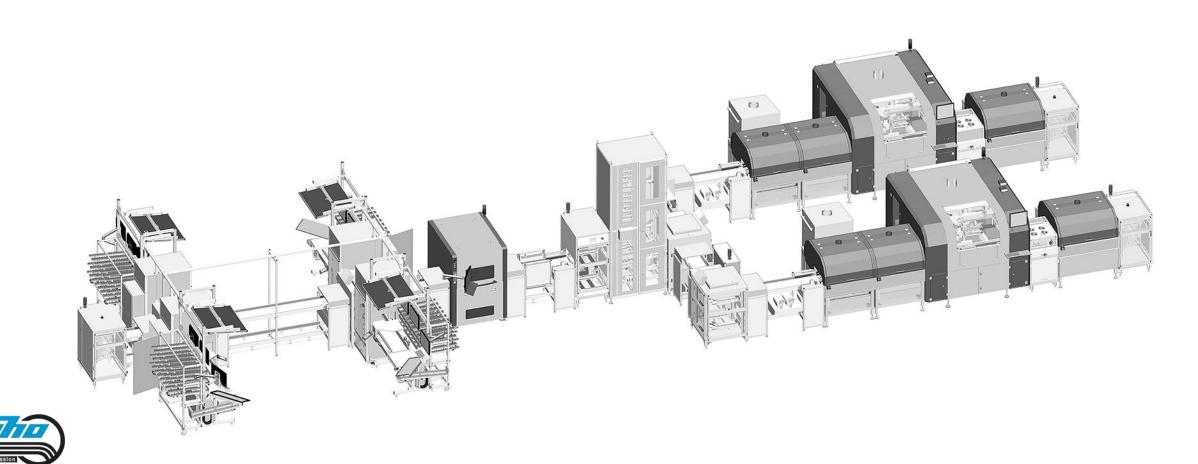




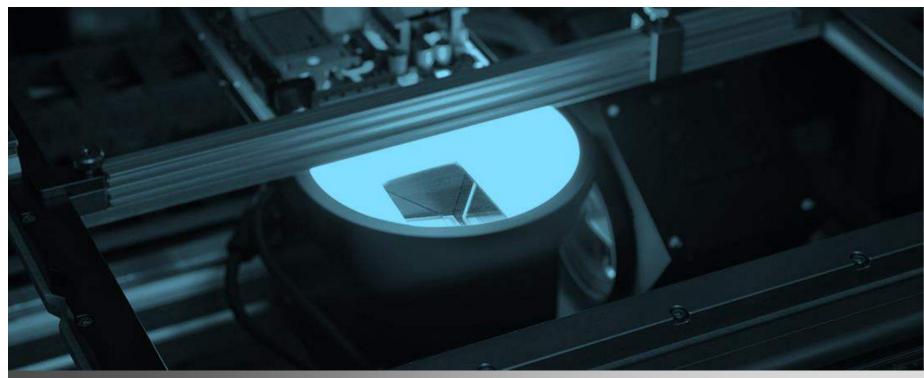


SEHO AssemblyCheck I SEHO PowerVision Example







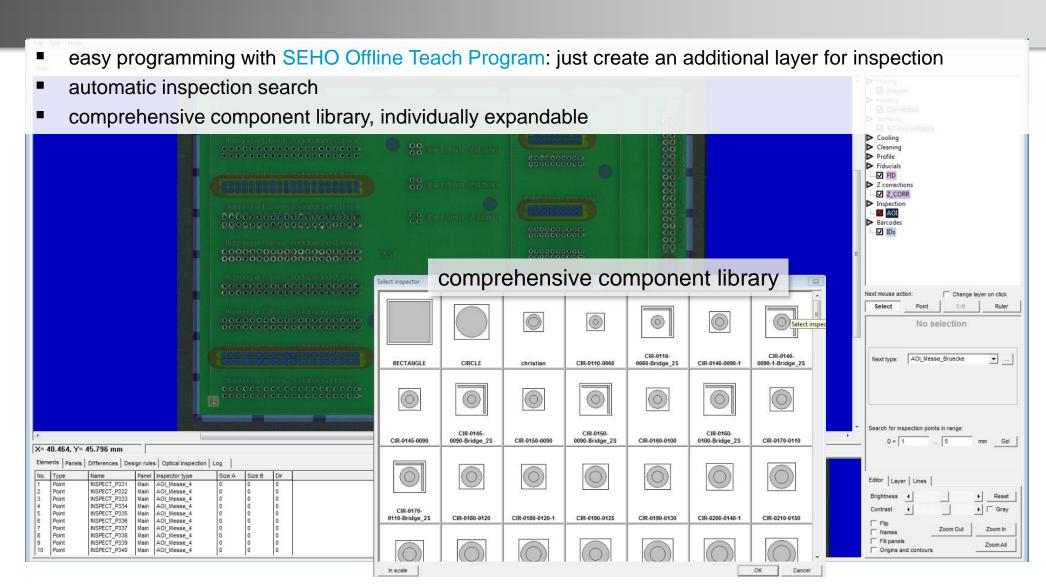


Programming: Simple and Efficient



Programming: Simple and Efficient







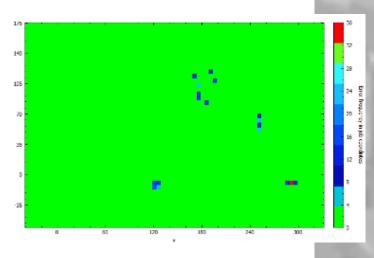


Effective Process Control

Jidoka – proactive error prevention

Trend Indicator – fast optimization of the test plan

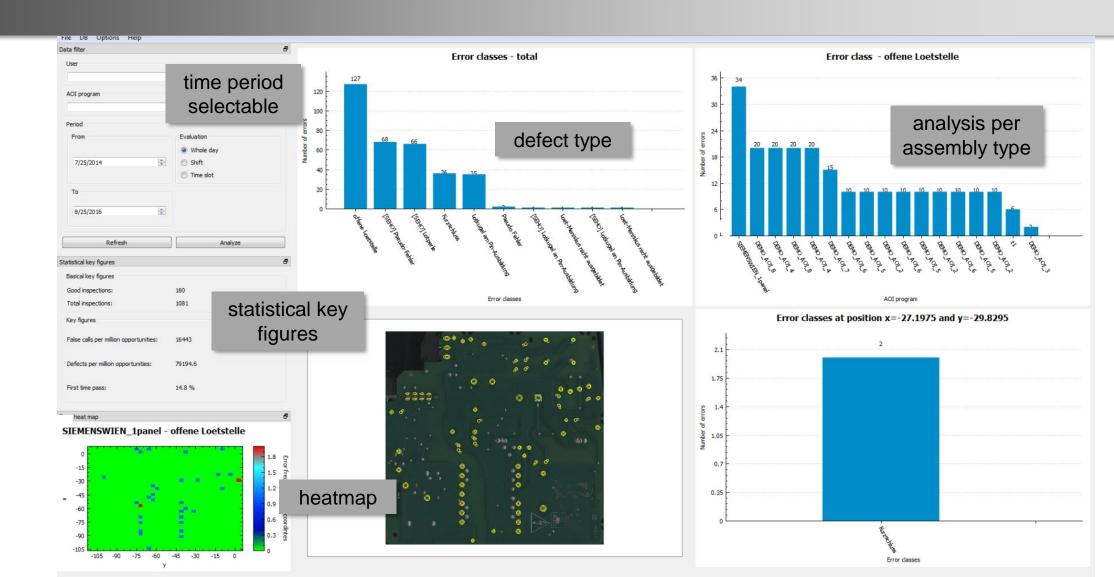
Heatmap – fast process optimization





SEHOspc – Statistical Tools for Process Optimization

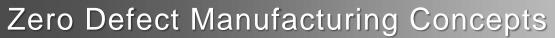








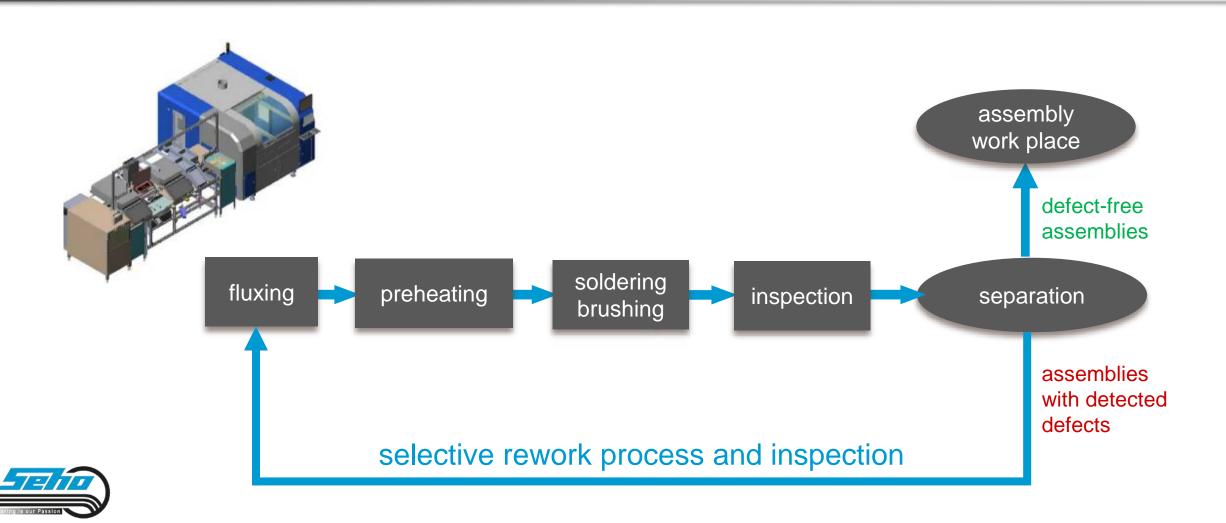






Zero Defect Manufacturing Concepts





Zero Defect Manufacturing Concepts

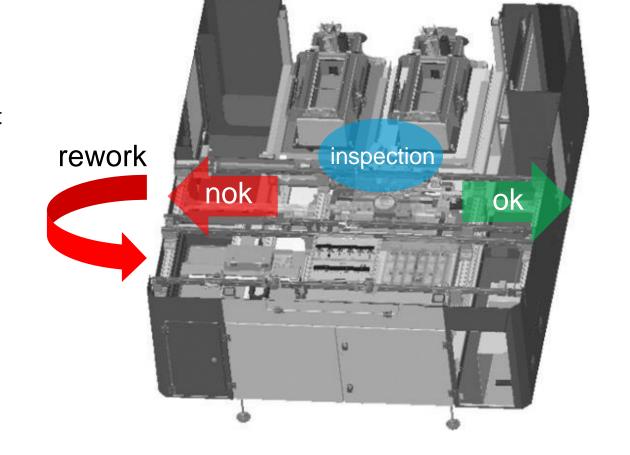


typical production sequence

- multiwave soldering process
- inspection system in delivery position
- good parts will be transported to the right

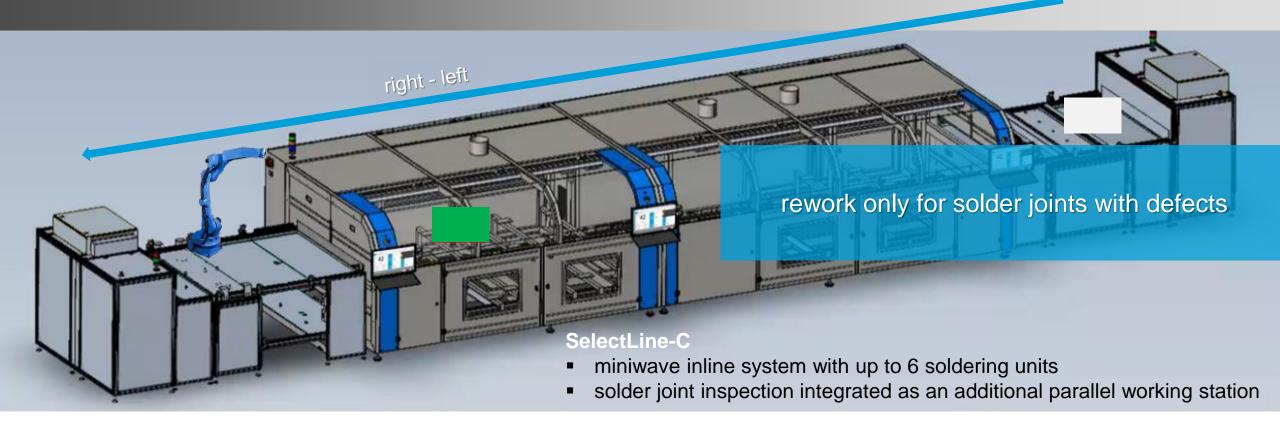
second run for parts with defects

- bad parts will be transported to the left
- software automatically creates a rework job - no verify required
- selective rework with miniwave
- inspection





Zero Defect Manufacturing Concepts

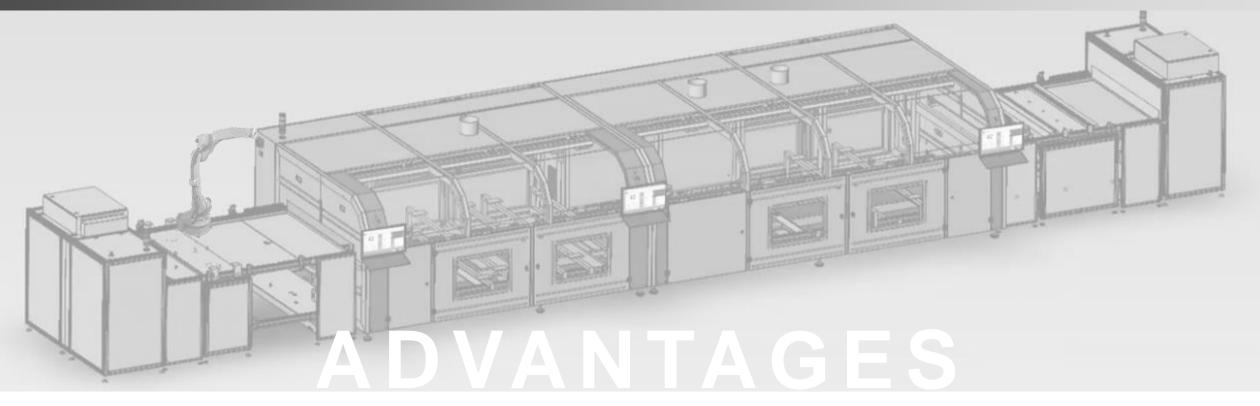


- carriers with good parts:automatically unloaded and loaded with new PCB
- carriers with bad parts:
 returned to the inlet for a second run



Zero Defect Manufacturing Concepts





- consistently high product quality
- optimized production costs
- no IPC-trained personnel required

- higher production speed
- complete traceability and documentation
- optimized use of resources
- scalability





Quelle: https://gfu.de/tech-guides/geraete-mit-ki-funktionen/



There's more to come: Roadmap

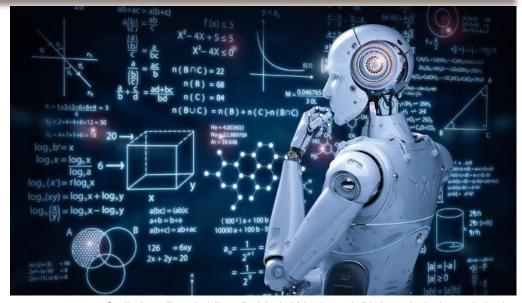


D-LEAP Distributive Machine Learning in Electronics Production



Summary

- Use of machine learning methods (ML) in the area of electronics production.
 - -> ML as a key technology for artificial intelligence (AI).
- improving machines/processes through ML-based controls.
- ML allows the creation of models for complex non-linear relationships from data.



Quelle: https://www.it-daily.net/it-sicherheit/cloud-security/ki-einsatz-in-der-it-security-ja-aber



The overall goal of the D-LEAP project is therefore the continuous monitoring and optimization of electronics production systems and processes using ML methods.

Goal for the systems from SEHO: Software tool that independently carries out verifications.

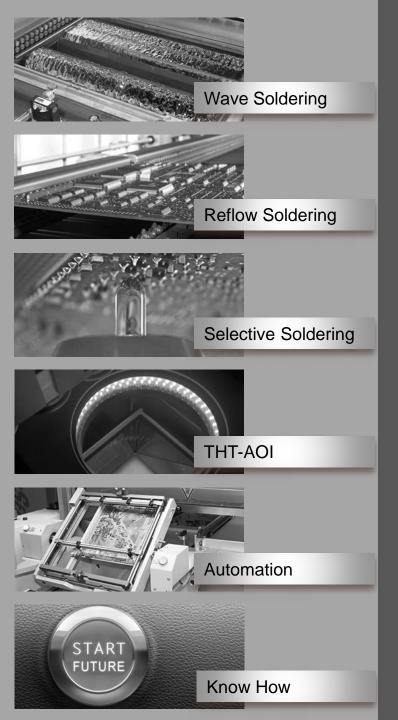
Distributed Machine Learning in Electronics Production I D-LEAP

Al Project / Al Verify



- a prototype software tool for carrying out an "Al Verify" is currently still being created
- independent verifications, with some additional information (e.g. safety value)
- testing in production: comparison between manual verify and AI verify
- if successful: real integration







Thank You!

We look forward to getting in touch with you.